



BGS18MA14

MIPI 2.0 SP8T switch for LTE Rx and Tx applications up to 3.8GHz

Key Features

- 0.1 to 3.8 GHz coverage for LTE application up to Band 43
- LTE TX power handling capabilities
- Ultra low insertion loss: 0.5dB for Band 41 and 0.7dB for Band 43
- Small form factor 2.0mm x 2.0mm
- Fully compatible with MIPI 2.0 RFFE standard
- No decoupling capacitors required (Unless DC applied on RF lines)

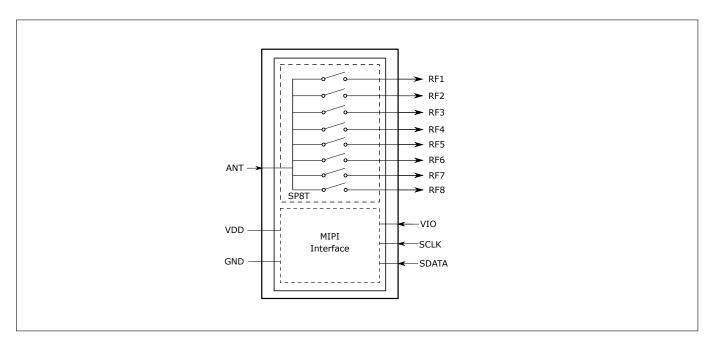
Applications

The SP8T switch is a band selection switch for LTE applications. With LTE TX power handling capability it is suitable for both LTE diversity path and LTE uplink Tx applications. The switch covers up to 3.8GHz so it supports Band 42 and Band 43.

Product Validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Block diagram



BGS18MA14

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Features

1 Features

- 0.1 to 3.8 GHz coverage for LTE application up to Band 43
- Suitable for LTE / WCDMA / TDCDMA Applications
- LTE TX Power Handling Capabilities
- Ultra low insertion loss: 0.5dB for Band 41 and 0.7dB for Band 43
- Small form factor 2.0mm x 2.0mm
- Fully compatible with MIPI 2.0 RFFE standard
- No decoupling capacitors required (Unless DC applied on RF lines)
- Low harmonic generation
- High port-to-port-isolation
- On chip control logic including ESD protection
- No power supply blocking required
- High EMI robustness
- RoHS and WEEE compliant package



C Infine

Description

This SP8T RF switch is a perfect solution for multimode handsets based on LTE, WCDMA and TDCDMA. It is based on Infineon's proprietary technology and has excellent RF performance. The ultra-low insertion loss helps customers to achieve high system sensitivity, the coverage of LTE Tx power and 3.8GHz enables very broad application. It features DC-free RF ports, external DC blocking capacitors at the RF ports are only required if DC voltage is applied externally.

Product Name	Marking	Package
BGS18MA14	A1	ATSLP-14-10



Maximum Ratings

2 Maximum Ratings

Parameter	Symbol		Value	S	Unit	Note / Test Condition
		Min.	Тур.	Max.	1	
Frequency Range	f	0.1	-	3.8	GHz	1)
Supply voltage ²⁾	V _{DD}	-0.5	-	3.9	V	-
RFFE supply voltage	V _{IO}	-0.5	-	2.5	V	-
RFFE input voltage (SCLK, SDATA)	VI	-0.5	-	V _{I0} +0.5	V	-
Storage temperature range	T _{STG}	-55	-	150	°C	-
RF input power at all TRx ports	P _{RF_max}	-	-	35	dBm	Short momentary, 50 Ω
ESD capability, CDM ³⁾	V _{ESD_{CDM}}	-500	-	+500	V	
ESD capability, HBM ⁴⁾	V _{ESD_{HBM}}	-1	-	+1	kV	
ESD capability, system level (RF port) ⁵⁾	V _{ESDANT}	-8	-	+8	kV	ANT vs system GND, with 27 nH
						shunt inductor
Junction temperature	Tj	_	_	125	°C	-

Table 1: Maximum Ratings, Table I at $T_A = 25$ °C, unless otherwise specified

¹⁾ Switch has a low-pass response. For higher frequencies, losses have to be considered for their impact on thermal heating. The DC voltage at RF ports V_{RFDC} has to be 0V.

²⁾ Note: Consider potential ripple voltages on top of V_{DD} . Including RF ripple, V_{DD} must not exceed the maximum ratings: $V_{DD} = V_{DC} + V_{Ripple}$.

³⁾ Field-Induced Charged-Device Model ANSI/ESDA/JEDEC JS-002. Simulates charging/discharging events that occur in production equipment and processes. Potential for CDM ESD events occurs whenever there is metal-to-metal contact in manufacturing.

⁴⁾ Human Body Model ANSI/ESDA/JEDEC JS-001 ($R = 1.5 \text{ k}\Omega$, C = 100 pF).

⁵⁾ IEC 61000-4-2 ($R = 330 \Omega$, C = 150 pF), contact discharge.

Warning: Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.

Values Unit Parameter Symbol Note / Test Condition Min. Typ. Max. Thermal resistance junction - soldering 62 K/W R_{thJS} _ _ _ point Maximum DC-voltage on RF-Ports and 0 0 ٧ No DC voltages allowed on RF-V_{RFDC} _ **RF-Ground** Ports

Table 2: Maximum Ratings, Table II at $T_A = 25 \text{ °C}$, unless otherwise specified



Operation ranges

3 Operation ranges

Table 3: Operation ranges at $T_A = -40 \,^{\circ}$ C to 85 $^{\circ}$ C

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
Supply Voltage	V _{DD}	1.7	2.85	3.4	V	-
Supply Current	I _{DD}	-	60	125	μΑ	-
Supply Current in Standby mode	I _{BATT_SB}	-	0.5	1	μA	VIO=low or MIPI lowpower mode
RFFE supply voltage	V _{IO}	1.65	1.8	1.95	V	-
RFFE input high voltage ¹	V _{IH}	0.7*V _{IO}	-	V _{IO}	V	-
RFFE input low voltage ¹	V _{IL}	0	-	0.3*V _{IO}	V	-
RFFE output high voltage ¹	V _{OH}	0.8*V _{IO}	-	V _{IO}	V	-
RFFE output low voltage ¹	V _{OL}	0	-	0.2*V _{IO}	V	-
RFFE control input capacitance	C _{Ctrl}	-	-	2	pF	-
RFFE supply current	I _{VIO}	-	2	-	μΑ	Idle State
VIO supply rise time	t _{VIO_rise}	50	-	450	μ s	-
VIO supply reset time	t _{VIO_reset}	10	-	-	μ s	-

¹SCLK and SDATA

Table 4: RF input power

Parameter	Symbol	Values		Unit	Note / Test Condition	
		Min.	Тур.	Max.		
RF input power on TRX ports	P _{RF}	-	-	32	dBm	CW / VSWR 1:1 / 25 °C
RF input power on TRX ports	P _{RF}	-	-	30	dBm	CW / VSWR 6:1 / 25 °C



RF Characteristics

4 RF Characteristics

Table 5: RF Characteristics at $T_A = -40$ °C...85 °C, $P_{IN} = 0$ dBm, Supply Voltage $V_{DD} = 1.7$ V...3.4V, unless otherwise specified. Open ports are terminated with 50 Ω

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Min. Typ. Max.			
Insertion Loss ¹⁾	I					1
		_	0.30	0.40	dB	698–960 MHz
All TRx Ports		_	0.35	0.55	dB	1428–1920 MHz
		-	0.40	0.65	dB	1990–2170 MHz
	IL	_	0.50	0.70	dB	2170-2690 MHz
		-	0.67	0.95	dB	3400-3600 MHz
		-	0.70	1.00	dB	3600-3800 MHz
Return Loss ¹⁾	l					
		19	23	-	dB	698–960 MHz
		14	17	-	dB	1428–1920 MHz
		13	16	-	dB	1990–2170 MHz
All TRx Ports	RL	12	16	-	dB	2170-2690 MHz
		10	16	-	dB	3400-3600 MHz
		10	15	-	dB	3600-3800 MHz
Isolation ^{1) 2)}	I		I			
		32	45	-	dB	698–960 MHz
		26	37	-	dB	1428–1920 MHz
		24	35	_	dB	1990–2170 MHz
Adjacent TRx Ports	ISO	22	34	_	dB	2170-2690 MHz
		19	30	_	dB	3400-3600 MHz
		17	29	_	dB	3600-3800 MHz
		32	50	_	dB	698–960 MHz
		28	45	_	dB	1428–1920 MHz
		26	42	_	dB	1990–2170 MHz
Non adjacent TRx Ports	ISO	24	40	-	dB	2170-2690 MHz
		22	38	-	dB	3400-3600 MHz
		22	35	-	dB	3600-3800 MHz
Harmonic Generation (UMTS	Band 1, Band 5) ¹⁾	I			1
2 nd harmonic generation	P _{H2}	-	-80	-70	dBm	27 dBm, 50 Ω, CW mod
3 rd harmonic generation	P _{H3}	-	-60	-55	dBm	27 dBm, 50 Ω, CW mod
Intermodulation Distortion (-	and 5) ¹⁾				I
2 nd order intermodulation	IMD2 low	-	-	-110	dBm	IMT, US Cell (see Tab. 7
3 rd order intermodulation	IMD3	_	_	-105	dBm	IMT, US Cell (see Tab. 8
2 ^{<i>nd</i>} order intermodulation	IMD2 high	_	_	-110	dBm	IMT, US Cell (see Tab. 7
Input Intercept point (UMTS I	-	1)				, , , , , , , , , , , , , , , , , , , ,
2^{nd} order intercept point	IIP2	110	_	_	dBm	IMT, US Cell (see Tab. 7
3 rd order intercept point	IIP3	65	_	_	dBm	IMT, US Cell (see Tab. 8

¹⁾On application board without any matching components.

 $^{\mbox{2})}$ Isolation to inactive ports when one path is active.



RF Characteristics

Table 6: Switching Time at $T_A = 25 \degree C$, $P_{IN} = 0 \ dBm$, Supply Voltage $V_{DD} = 1.7...3.4V$, unless otherwise specified

Parameter	Symbol				Unit	Note / Test Condition
				Max.		
Switching Time		_	I	-	I	1
RF Rise Time	t _{RT}	-	-	2	μs	10 % to 90 % RF signal
Switching Time	t _{sī}	-	3	4.5	μs	50% last SCLK falling edge to 90% RF signal, see Fig. 1
Power Up Settling Time	t _{Pup}			25	μs	After power down mode ¹⁾

 $^{1)}$ Don't change switch state during first 10 μs of power-up.

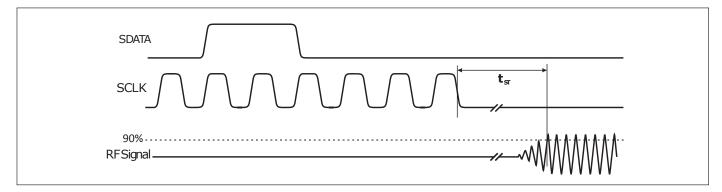


Figure 1: MIPI to RF time

Table 7: IMD2 Testcases

Band	CW tone 1 (MHz)	CW tone 1 (dBm)	CW tone 2 (MHz)	CW tone 2 (dBm)	
IMT	1950	20	190 (IMD2 low)	15	
	1950	20	4090 (IMD2 high)	15	
US Cell	925	20	45 (IMD2 low)	15	
	835	20	1715 (IMD2 high)	15	

Table 8: IMD3 Testcases

Band	CW tone 1 (MHz)	CW tone 1 (dBm)	CW tone 2 (MHz)	CW tone 2 (dBm)
IMT	1950	20	1760	-15
US Cell	835	20	790	-15



MIPI RFFE Specification

5 MIPI RFFE Specification

All sequences are implemented according to the 'MIPI Alliance Specification for RF Front-End Control Interface' document version 2.0 - 25. September 2014.

Table 9: MIPI Features

Feature	Supported	Comment
MIPI RFFE 1.10 and 2.0 standards	Yes	
Register 0 write command sequence	Yes	
Register read and write command sequence	Yes	
Extended register read and write command se-	Yes	
quence		
Support for standard frequency range operations	Yes	Up to 26 MHz for read and write
for SCLK		
Support for extended frequency range operations	Yes	Up to 52 MHz for write ¹⁾
for SCLK		
Half speed read	Yes	
Full speed read	Yes	
Full speed write	Yes	
Programmable Group SID	Yes	
Trigger functionality	Yes	
Broadcast / GSID write to PM TRIG register	Yes	
Reset	Yes	Via VIO, PM TRIG or software register ¹⁾
Status / error sum register	Yes	
Extended product ID register	Yes	
Revision ID register	Yes	
Group SID register	Yes	
USID_Sel pin	No	External pin for changing USID is not implemented
¹⁾ only supported by MIPL2.0 Standard	1	

¹⁾ only supported by MIPI 2.0 Standard

Table 10: Startup Behavior

Feature	State		Comment
Power status	Power	down	Power down mode after start-up
	mode		
Trigger function	Enabled		Enabled after start-up. Programmable via behavior control register



MIPI RFFE Specification

Table 11: Register Mapping, Table I

Register Address	Register Name	Data Bits	Function	Description	Default	Broadcast_ID Support	Trigger Support	R/W
0x00	SW_CTRL0	6:0	SW_CTRL0	RF Switch Control	0	No	Yes	R/W
0x1C	PM_TRIG	7	PWR_MODE(1), Operation Mode	0: Normal operation (ACTIVE)	1	Yes	No	R/W
				1: Low Power Mode (LOW POWER)				
		6	PWR_MODE(0), State Bit Vector	0: No action (ACTIVE)	0			
				1: Powered Reset (STARTUP to ACTIVE				
				to LOW POWER)				
		5	TRIGGER_MASK_2	0: Data masked (held in shadow REG)	0	No		
				1: Data not masked (ready for transfer to active REG)				
		4	TRIGGER_MASK_1	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		3	TRIGGER_MASK_0	0: Data masked (held in shadow REG)	0	1		
				1: Data not masked (ready for transfer to active REG)	_			
		2	TRIGGER_2	0: No action (data held in shadow REG)	0	Yes		
				1: Data transferred to active REG	1			
		1	TRIGGER_1	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
		0	TRIGGER_0	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
0x1D	PRODUCT_ID	7:0	PRODUCT_ID	This is a read-only register. However, during the programming of the USID a write command sequence is performed on this register, even though the write does not change its value.	0xCB	No	No	R
0x1E	MAN_ID	7:0	MANUFACTURER_ID [7:0]	This is a read-only register. However, during the programming of the USID, a write command sequence is performed on this register, even though the write does not change its value.	0x1A	No	No	R
0x1F	MAN_USID	7:6	RESERVED	Reserved for future use	00	No	No	R
		5:4	MANUFACTURER_ID [9:8]	These bits are read-only. However, dur- ing the programming of the USID, a write command sequence is performed on this register even though the write does not change its value.	01			
		3:0	USID[3:0]	Programmable USID. Performing a write to this register using the de- scribed programming sequences will program the USID in devices support- ing this feature. These bits store the USID of the device.	0x8	No	No	R/W



MIPI RFFE Specification

Table 12: Register Mapping, Table II

Register Address	Register Name	Data Bits	Function	Description	Default	Broadcast_ID Support	Trigger Support	R/W
0x20	EXT_PROD_ID ¹⁾	7:0	EXT_PRODUCT_ID		0x00	No	No	R
0x21	REV_ID	7:4	MAIN_REVISION		0x4	No	No	R/W
		3:0	SUB_REVISION		0x0	-		
0x22	GSID ¹⁾	7:4	GSID0[3:0]	Primary Group Slave ID.	0x0	No	No	R/W
		3:0	RESERVED	Reserved for secondary Group Slave ID.	0x0	-		
0x23 UDR_RST 7		UDR_RST	Reset all configurable non-RFFE Re- served registers to default values. 0: Normal operation 1: Software reset	0	No	No	R/W	
		6:0	RESERVED	Reserved for future use	0000000	-		
0x24	ERR_SUM ¹⁾	7	RESERVED	Reserved for future use	0	No	No	R
		6	COMMAND_FRAME_PAR_ERR	Command Sequence received with par- ity error — discard command.	0			
		5	COMMAND_LENGTH_ERR	Command length error.	0			
		4	ADDRESS_FRAME_PAR_ERR	Address frame with parity error.	0	-		
		3	DATA_FRAME_PAR_ERR	Data frame with parity error.	0	-		
		2	READ_UNUSED_REG	Read command to an invalid address.	0	-		
		1	WRITE_UNUSED_REG	Write command to an invalid address.	0	-		
		0	BID_GID_ERR	Read command with a BROADCAST_ID or GROUP_ID.	0			

¹⁾Only supported by MIPI 2.0 Standard



MIPI RFFE Specification

Table 13: Modes of Operation (Truth Table, Register_0)

State ¹⁾	Value (Bin.)	Mode		
0	0000000	ALL OFF (Isolation)		
1	00000010	RF1 ON		
2	00001010	RF2 ON		
3	00001110	RF3 ON		
4	00001011	RF4 ON		
5	0000001	RF5 ON		
6	00001001	RF6 ON		
7	00000110	RF7 ON		
8	00000100	RF8 ON		

¹⁾Chip state is 0 (isolation) in unused states



Package related information

6 Package related information

The switch has a package size of 2000 μ m in x-dimension and 2000 μ m in y-dimension with a maximum deviation of \pm 50 μ m in each dimension. Fig. 2 shows the footprint from top view. The definition of each pin can be found in Tab. 15.

Table 14: Mechanical Data

Parameter	Symbol	Value	Unit
Package X-Dimension	Х	2000 ± 50	μm
Package Y-Dimension	Y	2000 ± 50	μm
Package Height	Н	0.65 max	μm

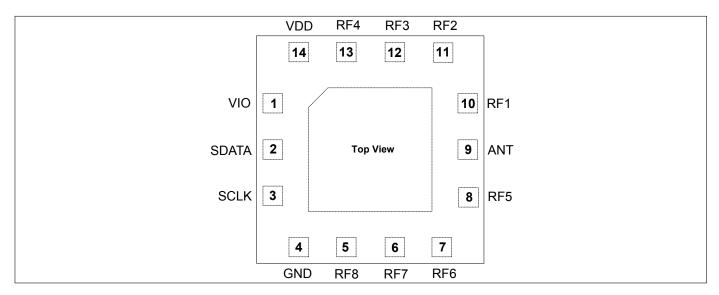


Figure 2: Footprint, top view

Table 15: Pin Definition

No.	Name	Pin Type	Function	
1	VIO	Power	MIPI RFFE Power Supply	
2	SDATA	I/O	MIPI RFFE Data I/O	
3	SCLK	I/O	MIPI RFFE Clock	
4	GND	Ground	Ground	
5	RF8	RF	RF-Port TRX No. 8	
6	RF7	RF	RF-Port TRX No. 7	
7	RF6	RF	RF-Port TRX No. 6	
8	RF5	RF	RF-Port TRX No. 5	
9	ANT	RF	RF Antenna Port	
10	RF1	RF	RF-Port TRX No. 1	
11	RF2	RF	RF-Port TRX No. 2	
12	RF3	RF	RF-Port TRX No. 3	
13	RF4	RF	RF-Port TRX No. 4	
14	VDD	Power	Power Supply	

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Package related information

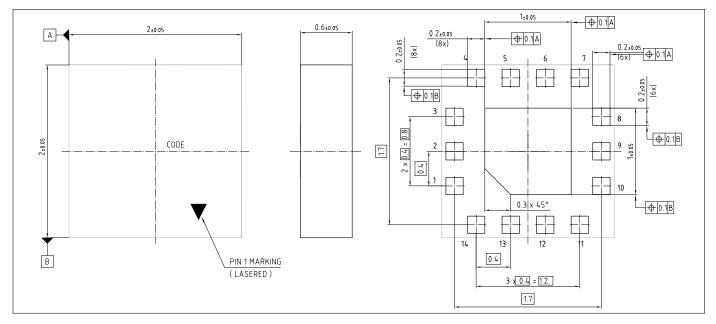


Figure 3: Package Outline Drawing (top, side and bottom views)

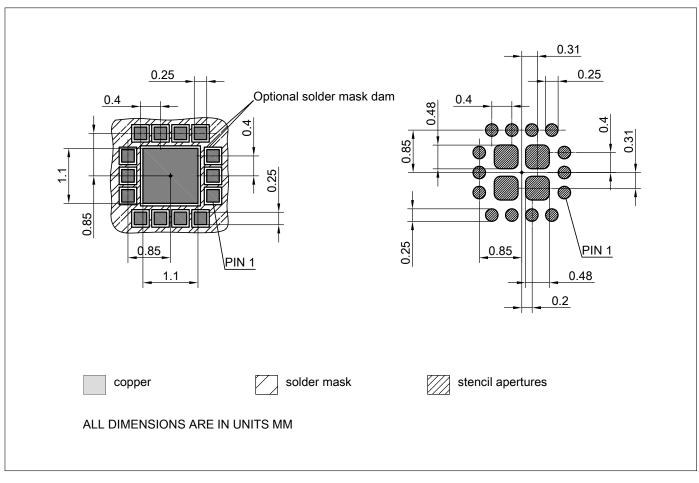


Figure 4: Land Pattern Drawing



Package related information

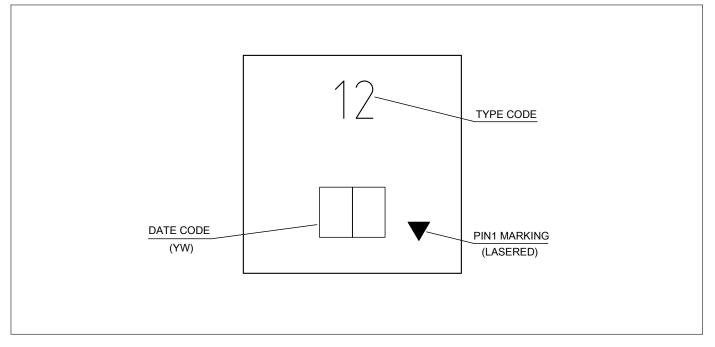


Figure 5: Laser marking

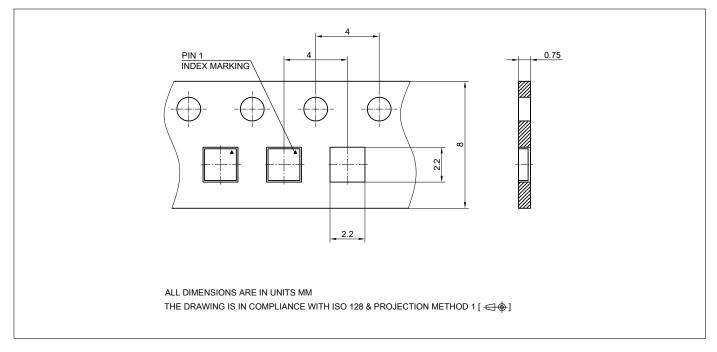


Figure 6: Carrier Tape



Package related information

Year	"Y"	Year	"Y"
2010	0	2020	0
2011	1	2021	1
2012	2	2022	2
2013	3	2023	3
2014	4	2024	4
2015	5	2025	5
2016	6	2026	6
2017	7	2027	7
2018	8	2028	8
2019	9	2029	9

Table 16: Year date code marking digit "Y"

Table 17: Week date code marking - digit "W"

Week	"W"	Week	"W"	Week	"W"	Week	"W"	Week	"W"
1	A	12	N	23	4	34	h	45	v
2	В	13	Р	24	5	35	j	46	x
3	С	14	Q	25	6	36	k	47	у
4	D	15	R	26	7	37	l	48	z
5	E	16	S	27	а	38	n	49	8
6	F	17	Т	28	b	39	р	50	9
7	G	18	U	29	с	40	q	51	2
8	н	19	V	30	d	41	r	52	3
9	J	20	W	31	e	42	s		
10	к	21	Y	32	f	43	t		
11	L	22	Z	33	g	44	u		



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Page or Item Subjects (major changes since previous revision)						
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